

October 2011

# FDD86110 N-Channel PowerTrench<sup>®</sup> MOSFET 100 V, 50 A, 10.2 m $\Omega$

# Features

• Max  $r_{DS(on)}$  = 10.2 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 12.5 A

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- Max  $r_{DS(on)}$  = 16 m $\Omega$  at V<sub>GS</sub> = 6 V, I<sub>D</sub> = 9.8 A
- 100% UIL tested
- RoHS Compliant

# **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench<sup>®</sup> process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

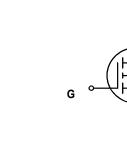
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# Application

DC - DC Conversion



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# **MOSFET Maximum Ratings** $T_C = 25 \ C$ unless otherwise noted

D-PAK (TO-252)

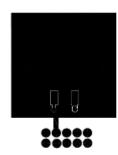
Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			100	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 ℃		50		
	-Continuous (Silicon limited)	T <sub>C</sub> = 25 ℃		80	٨	
D	-Continuous	T <sub>A</sub> = 25 ℃	(Note 1a)	12.5	Α	
	-Pulsed			60		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	135	mJ	
D	Power Dissipation	T <sub>C</sub> = 25 ℃		127	W	
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25 ℃	(Note 1a)	3.1	vv	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	C	
Thermal Cl	naracteristics					
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.98	~~~~		
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)		40	€/W		

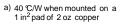
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD86110	FDD86110	D-PAK(TO-252)	13 "	12 mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		72		mV/℃
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2	2.8	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		-10		mV/℃
r <sub>DS(on)</sub> S	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 12.5 A		8.5	10.2	
		$V_{GS} = 6 \text{ V}, \text{ I}_{D} = 9.8 \text{ A}$		11.3	16	mΩ
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 12.5 \text{ A}, \text{T}_{J} = 125 \text{ C}$		15	18	
9fs	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 12.5 \text{ A}$		38		S
Dvnamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			1702	2265	pF
C <sub>oss</sub>	Output Capacitance	— V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, — f = 1MHz		379	505	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			17	30	pF
R <sub>g</sub>	Gate Resistance			0.5		Ω
	Characteristics			1	I	
t <sub>d(on)</sub>	Turn-On Delay Time			12	20	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 12.5 A,		5.4	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		19	35	ns
t <sub>f</sub>	Fall Time			3.9	10	ns
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$ $V_{DD} = 50 V,$		25	35	nC
Q <sub>gs</sub>	Gate to Source Charge	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 12.5 A		7.1		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			5.2		nC
Drain-Sou	Irce Diode Characteristics					
		V <sub>GS</sub> = 0 V, I <sub>S</sub> = 12.5 A (Note 2)		0.80	1.3	V
V <sub>SD</sub>	Source-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.6 A$ (Note 2)		0.72	1.2	

$V_{SD}$ Source-Drain Diode Forward Voltage $V_{GS} = 0.7, S = 2.6 \text{ A}$ (Note 2) $0.72$ $1.2$ $V_{GS} = 0.7, S = 2.6 \text{ A}$ $0.72$ $1.2$	
$t_{rr}$ Reverse Recovery Time $I_F = 12.5 \text{ A}, \text{ di/dt} = 100 \text{ A/us}$	ns
QrrReverse Recovery ChargeIF = 12.3 A, di/dt = 100 A/µs6096	nC

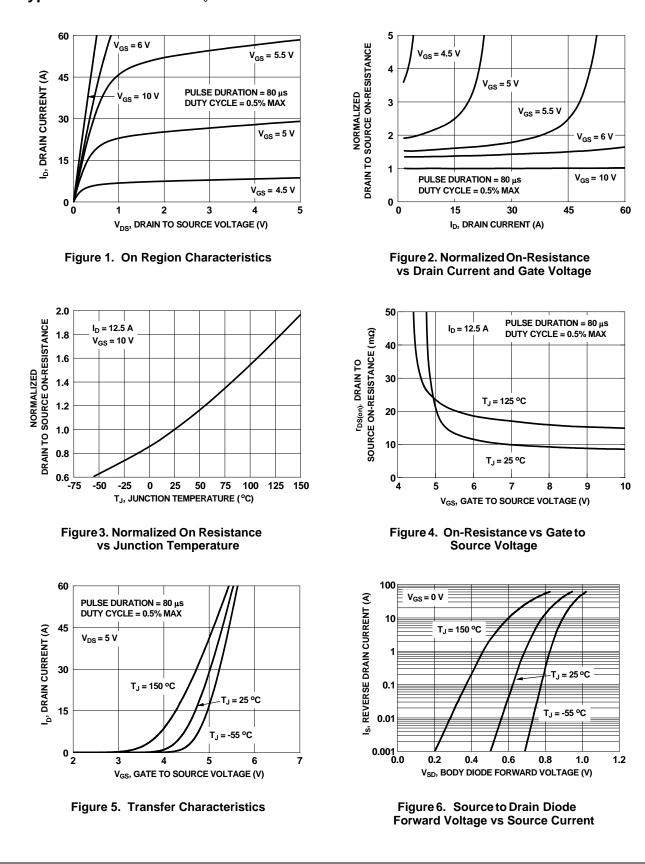
Notes: 1:  $R_{0JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{0JC}$  is guaranteed by design while  $R_{0JA}$  is determined by the user's board design.





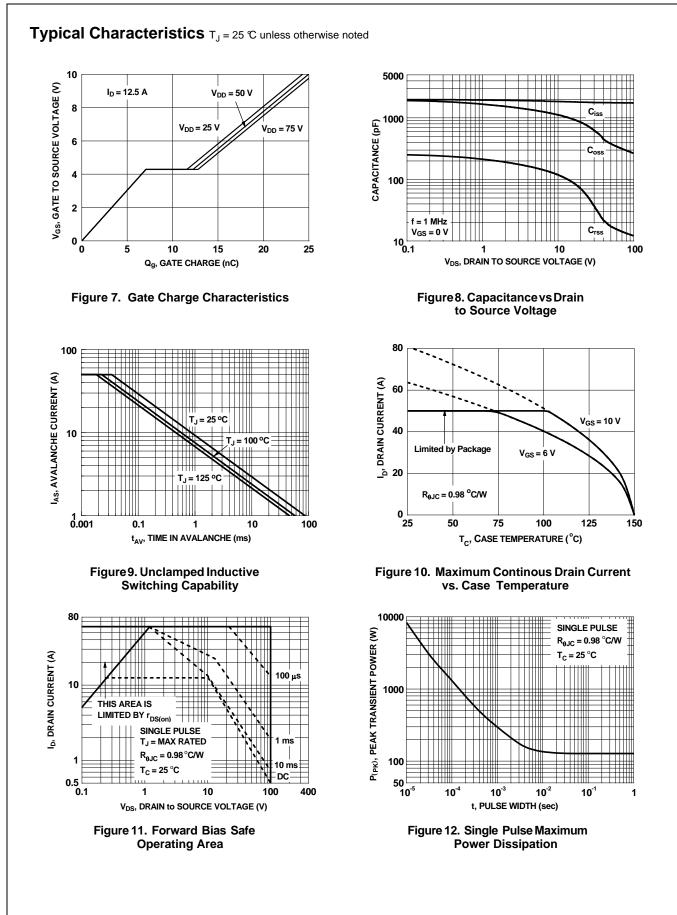


b) 96 °C/W when mounted on a minimum pad



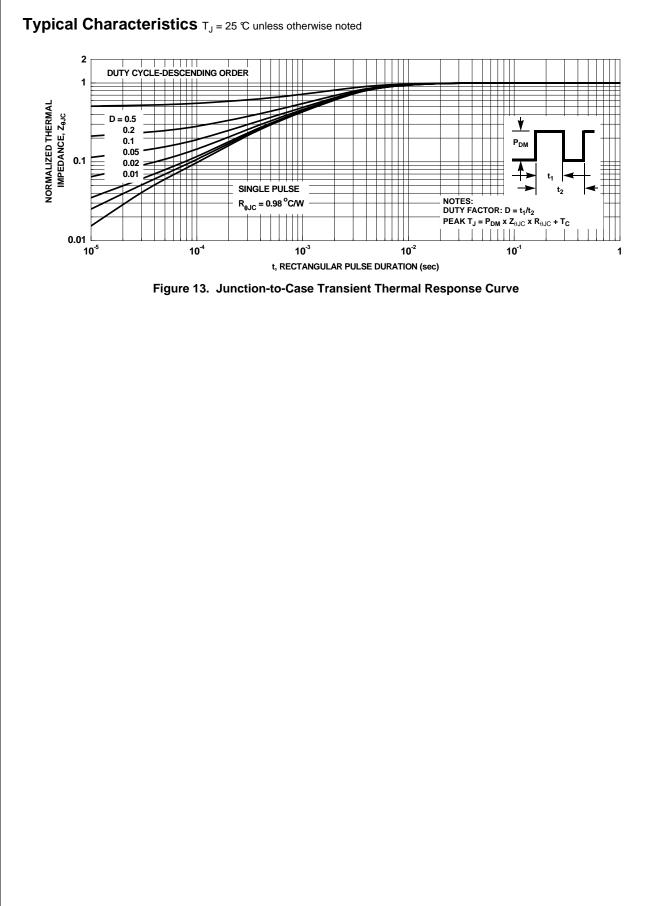
## Typical Characteristics T<sub>J</sub> = 25 °C unless otherwise noted

FDD86110 N-Channel PowerTrench<sup>®</sup> MOSFET



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